

NextPower 100 V, 2.07 mOhm, 267 Amp, N-channel MOSFET in LFPAK88 package

16 December 2022

Product data sheet

### 1. General description

NextPower 100 V, standard level gate drive MOSFET. Qualified to 175  $^\circ\text{C}$  and recommended for industrial and consumer applications.

### 2. Features and benefits

- Low Q<sub>rr</sub> for higher efficiency and lower spiking
- 267 Amps I<sub>D(max)</sub> continuous current rating
- Low  $Q_G \times R_{DSon}$  FOM for high efficiency switching applications
- Strong avalanche energy rating (E<sub>as</sub>)
- Avalanche rated and 100% tested
- Ha-free and RoHS compliant LFPAK88 package

### 3. Applications

- Synchronous rectifier in AC-DC and DC-DC
- Primary side switch
- BLDC motor control
- Full-bridge and half-bridge applications
- Battery protection

### 4. Quick reference data

Table 1. Qui	ck reference data						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	25 °C ≤ T <sub>j</sub> ≤ 175 °C		-	-	100	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; <u>Fig. 2</u>		-	-	267	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; <u>Fig. 1</u>		-	-	341	W
Tj	junction temperature			-55	-	175	°C
Static chara	acteristics						
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C; Fig. 11		-	1.63	2.07	mΩ
		V <sub>GS</sub> = 7 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C; <u>Fig. 11</u>		-	2	3	mΩ
Dynamic ch	naracteristics		-1	<b>I</b>			
Q <sub>GD</sub>	gate-drain charge	$I_D = 25 \text{ A}; V_{DS} = 50 \text{ V}; V_{GS} = 10 \text{ V};$		9	31	71	nC
Q <sub>G(tot)</sub>	total gate charge	Fig. 13; Fig. 14		80	161	242	nC
Avalanche	ruggedness			•			
E <sub>DS(AL)S</sub>	non-repetitive drain- source avalanche energy	$\begin{array}{l} I_{D} = 82 \; A; \; V_{sup} \leq \; 100 \; V; \; R_{GS} = 50 \; \Omega; \\ V_{GS} = 10 \; V; \; T_{j(init)} = 25 \; ^{\circ}C; \; unclamped; \\ t_{p} = 137 \; \mu s; \; \underline{Fig. \; 4} \end{array}$	[1]	-	-	732	mJ

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Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
Source-drain diode							
Qr	recovered charge	$I_{S} = 25 \text{ A}; \text{ d}_{S}/\text{d}t = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V}; \\ \text{V}_{DS} = 50 \text{ V}; \text{ Fig. 17}$		-	55	-	nC

[1] Protected by 100% test

### 5. Pinning information

Table 2.	Pinning infor	mation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		
2	S	source		D
3	S	source	0	
4	S	source		G(耳本)
mb	D	mounting base; connected to drain	LFPAK88 (SOT1235)	mbb076 S

### 6. Ordering information

Table 3. Ordering information           Type number	n Package				
	Name	Description	Version		
PSMN2R0-100SSF	LFPAK88	plastic, single-ended surface-mounted package (LFPAK88); 4 leads; 2 mm pitch; 8 mm x 8 mm x 1.6 mm body	SOT1235		

### 7. Marking

Table 4. Marking codes					
Type number	Marking code				
PSMN2R0-100SSF	X2F0S10S				

### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	$25 \text{ °C} \le T_j \le 175 \text{ °C}$	-	100	V
V <sub>DGR</sub>	drain-gate voltage	$25 °C ≤ T_j ≤ 175 °C; R_{GS} = 20 kΩ$	-	100	V
V <sub>GS</sub>	gate-source voltage		-20	20	V
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; <u>Fig. 1</u>	-	341	W
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; <u>Fig. 2</u>	-	267	А
		V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 100 °C; <u>Fig. 2</u>	-	189	А
I <sub>DM</sub>	peak drain current	pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^{\circ}C$ ; Fig. 3	-	1070	А
T <sub>stg</sub>	storage temperature		-55	175	°C

#### NextPower 100 V, 2.07 mOhm, 267 Amp, N-channel MOSFET in LFPAK88 package

Symbol	Parameter	Conditions		Min	Max	Unit
Tj	junction temperature			-55	175	°C
T <sub>sld(M)</sub>	peak soldering temperature			-	260	°C
Source-drain	diode			·		
IS	source current	T <sub>mb</sub> = 25 °C		-	267	А
I <sub>SM</sub>	peak source current	pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^{\circ}C$		-	1070	А
Avalanche rug	ggedness					·
E <sub>DS(AL)S</sub>	non-repetitive drain- source avalanche energy	$ \begin{split} & I_{D} = 82 \; A;  V_{sup} \leq \; 100 \; V; \; R_{GS} = 50 \; \Omega; \\ & V_{GS} = 10 \; V; \; T_{j(init)} = 25 \; ^{\circ}C; \; unclamped; \\ & t_{p} = 137 \; \mus; \; \underline{Fig. 4} \end{split} $	[1]	-	732	mJ
I <sub>AS</sub>	non-repetitive avalanche current	$V_{sup} \le 100 \text{ V}; V_{GS} = 10 \text{ V}; T_{j(init)} = 25 \text{ °C}; R_{GS} = 50 \Omega; Fig. 4$	[1]	-	82	A

[1] Protected by 100% test

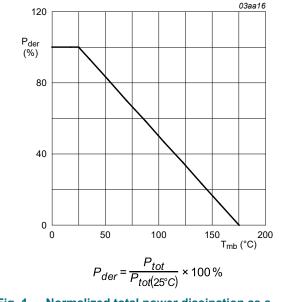
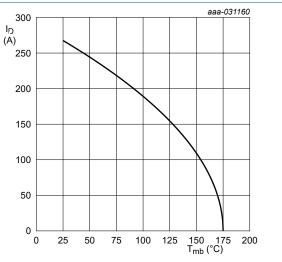


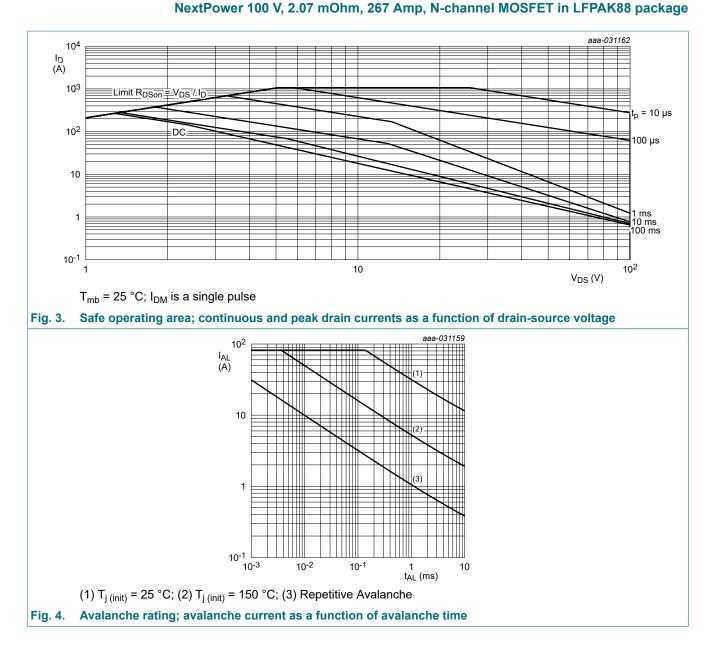
Fig. 1. Normalized total power dissipation as a function of mounting base temperature



 $V_{GS} \ge 10 V$ 

(1) 267A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

Fig. 2. Continuous drain current as a function of mounting base temperature

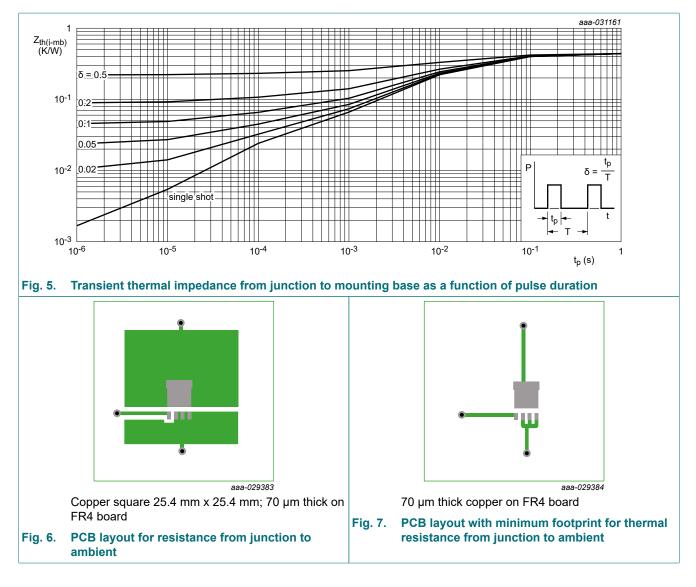


### 9. Thermal characteristics

#### Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	<u>Fig. 5</u>		-	0.2	0.44	K/W
R <sub>th(j-a)</sub>		Fig. 6		-	35	-	K/W
junction to ambient	junction to ambient	<u>Fig. 7</u>		-	70	-	K/W

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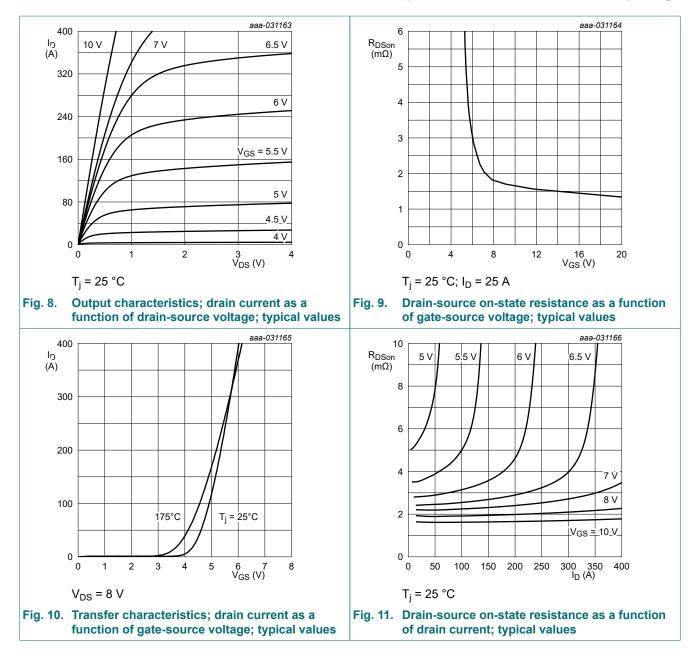


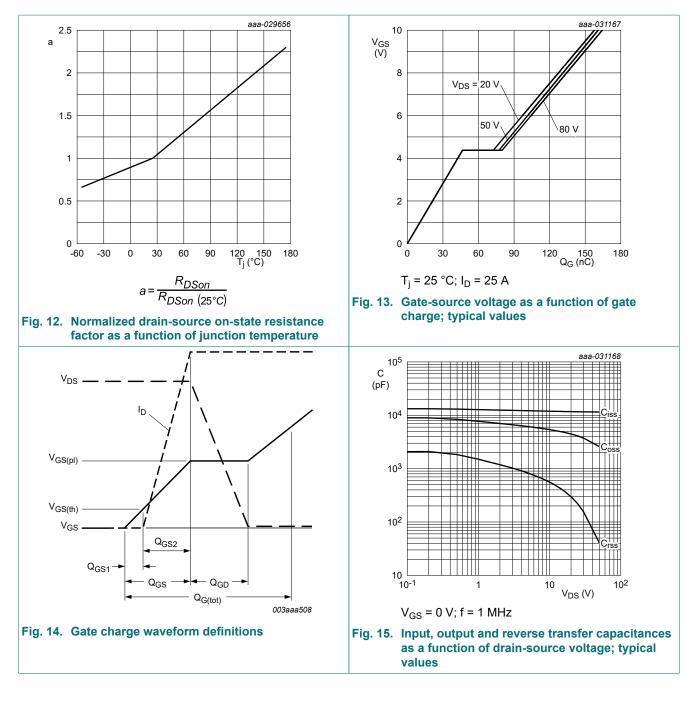
### **10. Characteristics**

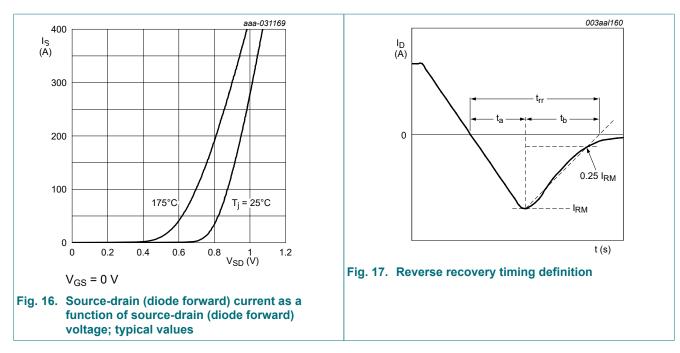
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static charac	teristics	· · ·	I			
V <sub>(BR)DSS</sub>	drain-source	I <sub>D</sub> = 250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	100	-	-	V
	breakdown voltage	I <sub>D</sub> = 250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = -55 °C	90	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C}$	2	3	4	V
		I <sub>D</sub> = 1 mA; V <sub>DS</sub> =V <sub>GS</sub> ; T <sub>j</sub> = 175 °C	-	1.6	-	V
		I <sub>D</sub> = 1 mA; V <sub>DS</sub> =V <sub>GS</sub> ; T <sub>j</sub> = -55 °C	-	3.5	-	V
$\Delta V_{GS(th)} / \Delta T$	gate-source threshold voltage variation with temperature	25 °C ≤ T <sub>j</sub> ≤ 150 °C	-	-8.8	-	mV/K
I <sub>DSS</sub>	drain leakage current	V <sub>DS</sub> = 100 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	0.1	1	μA
		V <sub>DS</sub> = 100 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 125 °C	-	46	200	μA
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = 20 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	2	100	nA
		V <sub>GS</sub> = -20 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	2	100	nA

PSMN2R0-100SSF

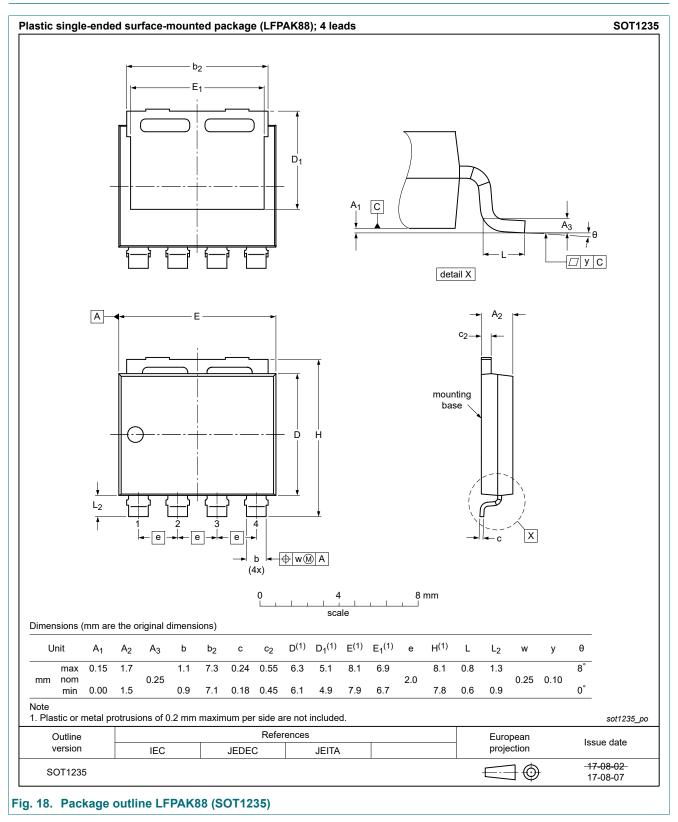
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C; Fig. 11	-	1.63	2.07	mΩ
		V <sub>GS</sub> = 7 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C; <u>Fig. 11</u>	-	2	3	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 100 °C; Fig. 12	-	2.6	3.3	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 175 °C; Fig. 12	-	3.5	4.8	mΩ
R <sub>G</sub>	gate resistance	f = 1 MHz; T <sub>j</sub> = 25 °C	0.7	1.4	2.8	Ω
Dynamic ch	aracteristics			-		
Q <sub>G(tot)</sub>	total gate charge	I <sub>D</sub> = 25 A; V <sub>DS</sub> = 50 V; V <sub>GS</sub> = 10 V; Fig. 13; Fig. 14	80	161	242	nC
		I <sub>D</sub> = 0 A; V <sub>DS</sub> = 0 V; V <sub>GS</sub> = 10 V; <u>Fig. 13;</u> Fig. 14	-	83	-	nC
Q <sub>GS</sub>	gate-source charge	I <sub>D</sub> = 25 A; V <sub>DS</sub> = 50 V; V <sub>GS</sub> = 10 V; Fig. 13; Fig. 14	28	47	66	nC
Q <sub>GS(th)</sub>	pre-threshold gate- source charge		-	31.5	-	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate- source charge		-	15.5	-	nC
Q <sub>GD</sub>	gate-drain charge		9	31	71	nC
V <sub>GS(pl)</sub>	gate-source plateau voltage	I <sub>D</sub> = 25 A; V <sub>DS</sub> = 50 V; <u>Fig. 13; Fig. 14</u>	-	4.4	-	V
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = 50 V; V <sub>GS</sub> = 0 V; f = 0.5 MHz;	6900	11530	16140	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C; <u>Fig. 15</u>	1550	2590	4150	pF
C <sub>rss</sub>	reverse transfer capacitance		4	41	107	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS} = 50 \text{ V}; \text{ R}_{L} = 2 \Omega; \text{ V}_{GS} = 10 \text{ V};$	-	42	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 5 \Omega$	-	36	-	ns
t <sub>d(off)</sub>	turn-off delay time	1	-	95	-	ns
t <sub>f</sub>	fall time	1 -	-	47	-	ns
Source-drai	in diode	, <u> </u>	1	-	1	
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = 25 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C; <u>Fig. 16</u>	-	0.8	1	V
t <sub>rr</sub>	reverse recovery time	I <sub>S</sub> = 25 A; dI <sub>S</sub> /dt = -100 A/μs; V <sub>GS</sub> = 0 V;	-	54	-	ns
Q <sub>r</sub>	recovered charge	V <sub>DS</sub> = 50 V; <u>Fig. 17</u>	-	55	-	nC



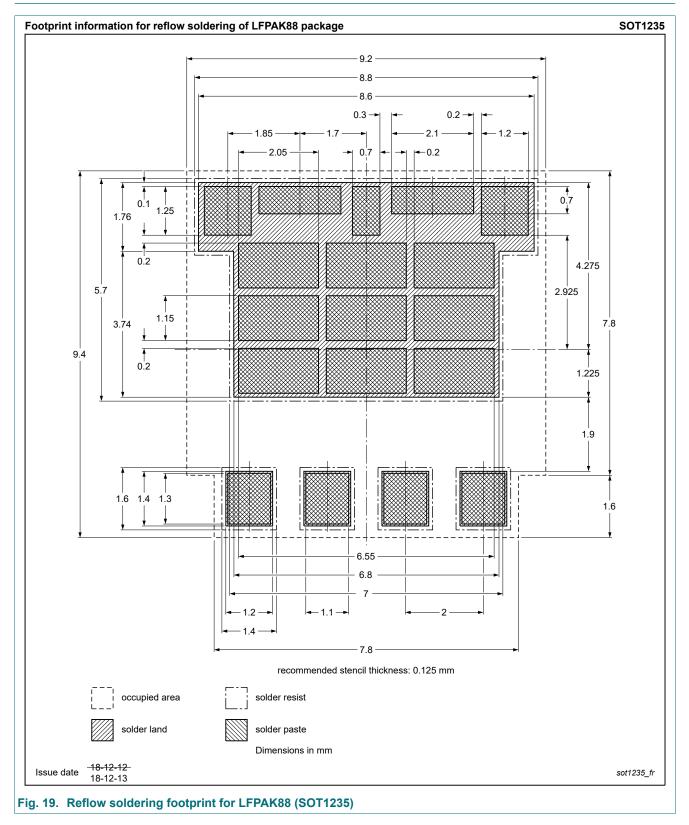




### 11. Package outline



### 12. Soldering



### 13. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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